

# GaAs INTEGRATED CIRCUIT $\mu$ PG132G

# L-BAND SPDT SWITCH

#### DESCRIPTION

μPG132G is an L-Band SPDT (Single Pole Double Throw) GaAs FET switch which was developed for digital cellular or cordless telephone application.

The device can operate from 100 MHz to 2.5 GHz, having the low insertion loss.

It housed in an original 8 pin SSOP that is smaller than usual 8 pin SOP and easy to install and contributes to miniaturizing the system.

It can be used in wide-band switching applications.

#### **FEATURES**

Maximum transmission power: 0.6 W (typ.)

 Low insertion loss : 0.6 dB (typ.) at f = 2 GHz

 High switching speed 30 ns

+3 V/0 V control voltage

 Small package : 8 pins SSOP

#### **APPLICATION**

• Digital cordless telephone : PHS, PCS, DECT etc.

• Digital hand-held cellular phone, WLAN

#### ORDERING INFORMATION

PART NUMBER PACKAGE			PACKING FORM			
	μPG132G-E1 8 pin plastic SSOP		Carrier tape width 12 mm. QTY 2kp/Reel.			

For evaluation sample order, please contact your local NEC sales office.

# ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

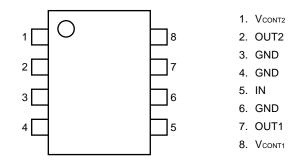
Control Voltage	VCONT	-0.6 to +6	V
Input Power	Pin	31	dBm
Total Power Dissipation	Ptot	0.4	W
Operating Case Temperature	Topt	-65 to +90	°C
Storage Temperature	T <sub>stg</sub>	-65 to +150	°C

CAUTION: The IC must be handled with care to prevent static discharge because its circuit is composed of GaAs MES FET.





# PIN CONNECTION DIAGRAM (Top View)

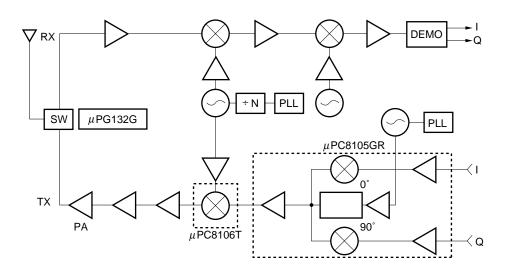


# SPDT SWITCH IC SERIES PRODUCTS

PART NUMBER	P <sub>in</sub> (1dB) (dBm)	L <sub>INS</sub> (dB)	ISL (dB)	Vcont (V)	PACKAGE	APPLICATIONS
μPG130GR	+34	0.5 @1G	32 @1G	-5/0	8 pin SOP	PDC, IS-136, PHS
μPG131GR	+30	0.6 @2G	23 @2G	-4/0	(225 mil)	PHS, PCS, WLAN
μPG130G	+34	0.5 @1G	32 @1G	-5/0	8 pin SSOP	PDC, IS-136, PHS
μPG131G	+30	0.6 @2G	23 @2G	-4/0	(175 mil)	PHS, PCS, WLAN
μPG132G	+30	0.6 @1G	22 @2G	+3/0		PHS, PCS, WLAN
μPG133G	+25	0.6 @2G	20 @2G	-3/0		DIVERSITY etc

Remark: As for detail information of series products, please refer to each data sheet.

# **APPLICATION EXAMPLE (PHS)**





#### RECOMMENDED OPERATING CONDITIONS

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Control Voltage (ON)	VCONT	+2.7	+3.0	+5.0	V
Control Voltage (OFF)	VCONT	-0.2	0	+0.2	V
Input Power Level	Pin		27	29	dBm

# ELECTRICAL CHARACTERISTICS (TA = 25 °C)

CHARACTERISTICS	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITION
Insertion Loss	Lins		0.6	1.0	dB	
			0.8Note1			f = 2.5 GHz
Isolation	ISL	20	22		dB	
		20 <sup>Note1</sup>				f = 2.5 GHz
Input Return Loss	RLin	11			dB	f = 100 MHz to 2 GHz
Output Return Loss	RLout	11			dB	Vcont1 = 0 V
Input Power at 1dB	Pin (1dB)Note2	27	30		dBm	Vcont2 = +3 V
Compression Point						or
Switching Speed	tsw		30		ns	VCONT1 = +3 V
Control Current	Ісонт	·		50	μΑ	VCONT2 = 0 V

Notes 1: Characteristic for reference at 2.0 to 2.5 GHz.

2: P<sub>in</sub> (1dB) is measured the input power level when the insertion loss increase more 1dB than that of linear range.

All other characteristics are measured in linear range.

#### NOTE ON CORRECT USE

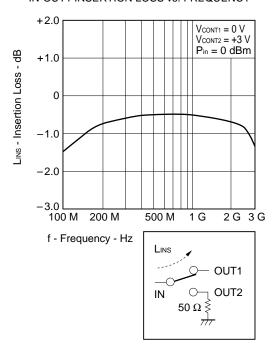
- When the μPG132G is used it is necessary to use DC blocking capacitor for No. 2 pin (OUT2), No. 5 pin (IN) and No. 7 pin (OUT1). The value of DC blocking capacitors should be chosen to accommodate the frequency of operation.
- Insertion loss and isolation of the IN-OUT2 is better than that of IN-OUT1, because No. 7 pin (OUT1) is placed to same side of No. 5 pin (IN).
- The distance between IC's GND pins and ground pattern of substrate should be as shorter as possible to avoid parasitic parameters.

# **NEC**

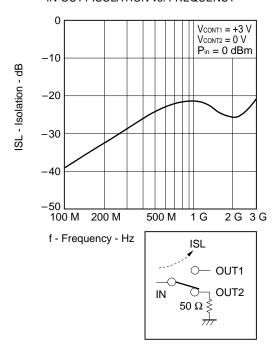
#### TYPICAL CHARACTERISTICS (TA = 25 °C)

Note This data is including loss of the test fixture.

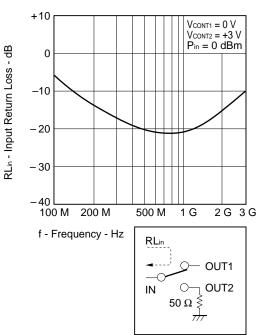
#### IN-OUT1 INSERTION LOSS vs. FREQUENCY



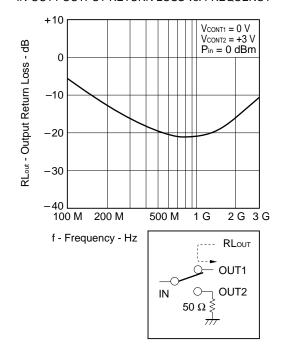
#### IN-OUT1 ISOLATION vs. FREQUENCY



# IN-OUT1 INPUT RETURN LOSS vs. FREQUENCY

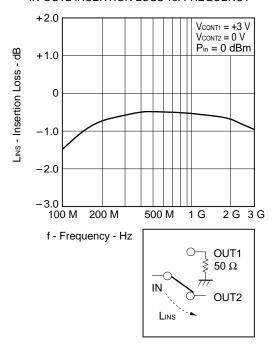


#### IN-OUT1 OUTPUT RETURN LOSS vs. FREQUENCY

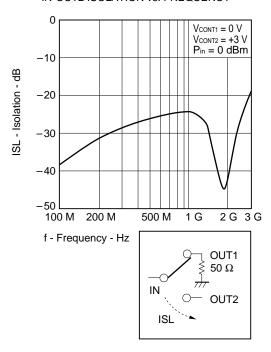


# **NEC**

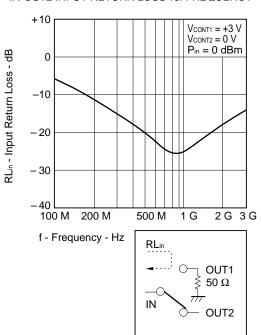
#### IN-OUT2 INSERTION LOSS vs. FREQUENCY



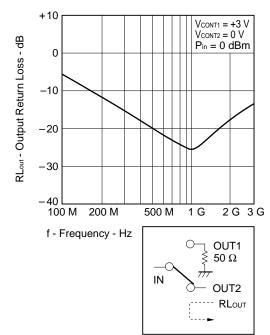
#### IN-OUT2 ISOLATION vs. FREQUENCY



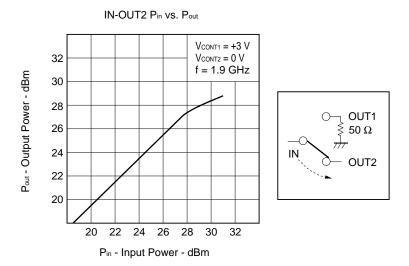
#### IN-OUT2 INPUT RETURN LOSS vs. FREQUENCY



#### IN-OUT2 OUTPUT RETURN LOSS vs. FREQUENCY

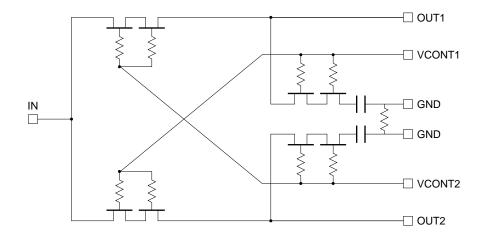




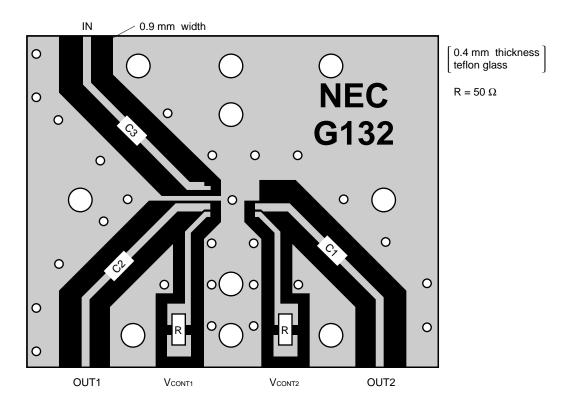


# **Internal Equivalent Circuit**

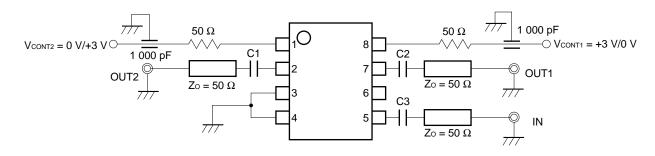
Between the GND pins and FETs of this IC, a capacitor of 3.6 pF for floating is inserted to realize switching between positive voltages of +3 V and 0 V. However, the basic configuration of the  $\mu$ PG132G is the same as that of the  $\mu$ PG131G. In addition, the  $\mu$ PG132G has a monitor pin and a resistor to check the internal circuitry.



#### **TEST BOARD**



# TEST CIRCUIT



C1, C2, C3 = 51 pF

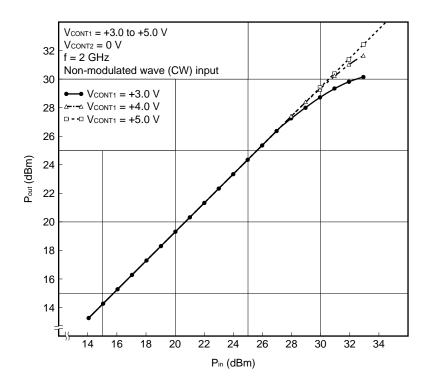


#### **APPLICATIONS**

# Dependency on control voltage

The input/output characteristics, insertion loss, and isolation characteristics hardly fluctuate up to  $P_{in}$  (1 dB) = +27 dBm, even if the control voltage is changed in a range of +3.0 V to +5.0 V. When the IC is used at  $P_{in}$  = +22 dBm in a PHS extension, therefore, the characteristics of the IC do not fluctuate even if a battery whose discharging characteristics fluctuate, such as a lithiumion battery, is used.

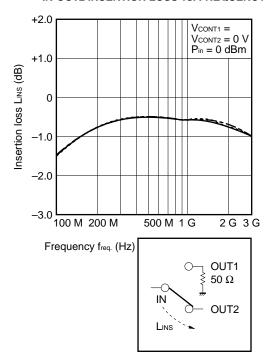
#### Relation between Control Voltage and Input/Output Characteristics



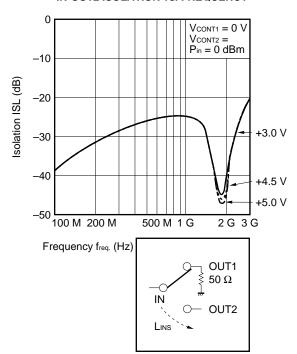
# **NEC**

#### Relation between Small Signal Characteristics and Control Voltage

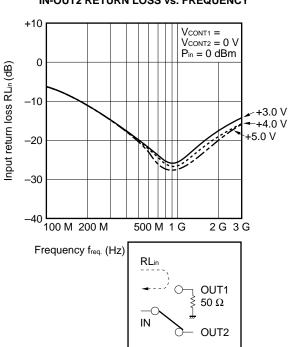
#### **IN-OUT2 INSERTION LOSS vs. FREQUENCY**



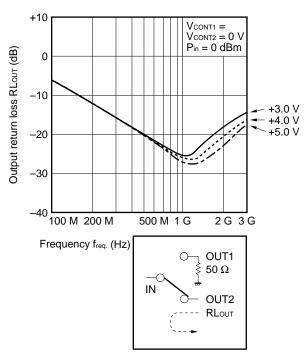
#### **IN-OUT2 ISOLATION vs. FREQUENCY**



#### IN-OUT2 RETURN LOSS vs. FREQUENCY



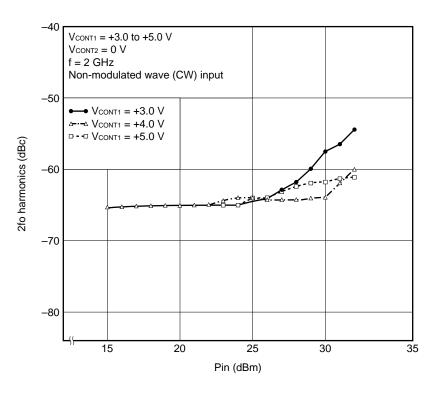
#### IN-OUT2 OUTPUT RETURN LOSS vs. FREQUENCY



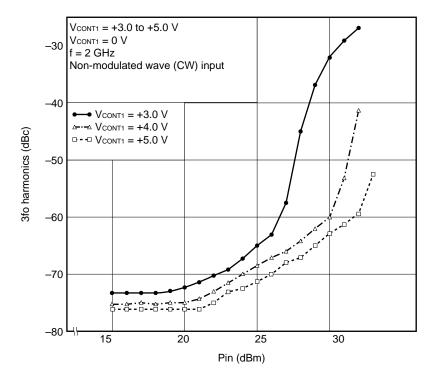
---- Vcont1 = +3 V (isolation only, Vcont2 = +3 V)
---- Vcont1 = +4 V (isolation only, Vcont2 = +4 V)
--- Vcont1 = +5 V (isolation only, Vcont2 = +5 V)

The measured values include all losses of the measuring jig.

# Relation between Control Voltage and Second Harmonic



# Relation between Control Voltage and Third Harmonic

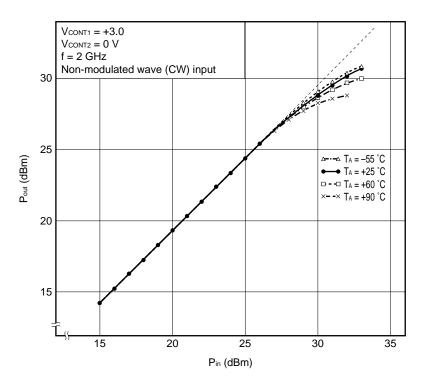




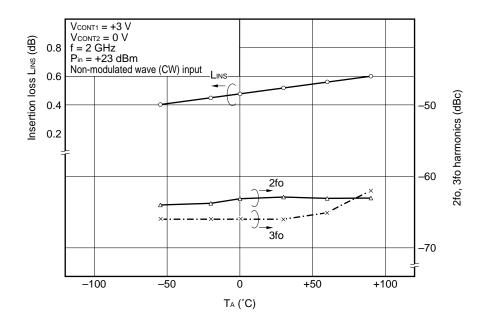
#### **Temperature characteristics**

Next, results from evaluating the temperature characteristics of the  $\mu$ PG132G are shown. As shown, favorable characteristics are obtained in a range of T<sub>A</sub> = -55 to +90 °C. The temperature coefficient of the insertion loss is about +0.0014 dB/°C, indicating that the higher the temperature, the more the insertion loss.

#### **Temperature Characteristics of Input/Output**



Temperature Characteristics of Insertion Loss, and Double and Triple Harmonics

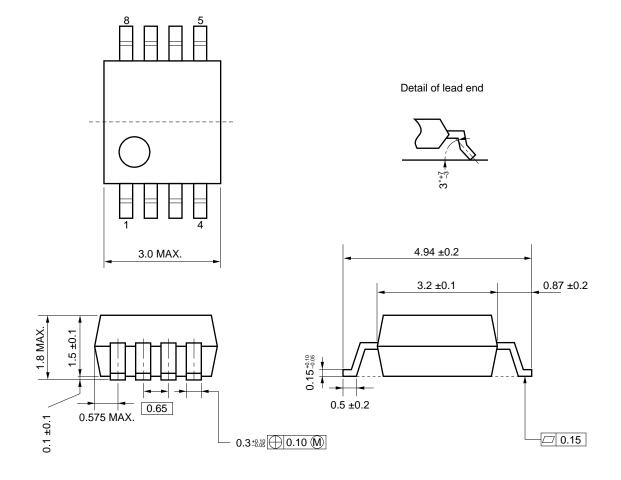




# $\mu\text{PG}132\text{G}$ Truth table of switching by condition of control voltage

		Vcc	ONT1		
		+3 V	0 V		
Vcont2	+3 V	IN — OUT1 O— OUT2	O OUT1 O OUT2		
	0 V	IN — O — OUT1 — OUT2	IN —O O— OUT 1 O— OUT 2		

# 8-PIN PLASTIC SHRINK SOP (175 mil) (Unit mm)





#### RECOMMENDED SOLDERING CONDITIONS

This product should be soldered in the following recommended conditions. Other soldering methods and conditions than the recommended conditions are to be consulted with our sales representatives.

# [µPG132G]

Soldering process	Soldering conditions	Recommended condition symbol
Infrared ray reflow	Hour: within 30 s. (more than 210 °C) Time: 2 time, Limited days: no. Note	
VPS		
Wave Soldering	Soldering tub temperature: less than 260 °C, Hour: within 10 s. Time: 1 time, Limited days: no. Note	WS60-00-1
Pin part heating	Pin area temperature: less than 300 °C, Hour: within 10 s. Limited days: no. Note	

Note It is the storage days after opening a dry pack, the storage conditions are 25 °C, less than 65 %, RH.

Caution The combined use of soldering method is to be avoided (However, except the pin area heating method).

For details of recommended soldering conditions for surface mounting, refer to information document **SEMICONDUCTOR DEVICE MOUNTING TECHNOLOGY MANUAL (C10535EJ7V0IF00).** 

NEC  $\mu$ PG132G

The application circuits and their parameters are for references only and are not intended for use in actual designin's.

#### Caution

The Great Care must be taken in dealing with the devices in this guide.

The reason is that the material of the devices is GaAs (Gallium Arsenide), which is designated as harmful substance according to the Japanese law concerned.

Keep the law concerned and so on, especially in case of removal.

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Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)

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Anti-radioactive design is not implemented in this product.

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